**HONG KONG SCIENCE AND TECHNOLOGY PARKS CORPORATION**

**Request for Proposal (RFP) on**

**Development and Implementation of**

**INNOPARK Admission System**

**(Ref: RFP/2023/CEOD/282)**

**Application Deadline: 3:00 pm, Friday, 08 Dec 2023**

HKSTP intends to invite potential tenderers to tender for RFP on Development and Implementation of INNOPARK Admission System for HKSTP. The objective of this exercise is to seek a supplier to develop a one-stop solution and implement a system which consists of (but not only limited to):

* Online expression of interest form
* Assessment scoresheet calculation
* Online tender system for admission into InnoPark
* Evaluation for application
* Integration with HKSTP’s existing system, etc

The scope of work and the relevant specifications, terms and conditions are outlined in the RFP document which can be found in HKSTP's Tender System (<https://tender.hkstp.org>) under Ref. RFP/2023/CEOD/282. If your company is interested in bidding this tender, please submit the duly completed Technical Proposal and Price Proposal via HKSTP's Tender System (https://tender.hkstp.org) by no later than **3:00 pm (Hong Kong time) on 8 Dec 2023**. Late submission may not be considered.

For enquiries, please submit the questions through HKSTP’s Tender System.

***New Supplier Registration***

To submit the offer to this tender exercise, the tenderer must be a registered supplier in HKSTP eTENDER (<https://tender.hkstp.org/>, please click “Supplier” and finish “Registration” and “Account Activation” procedures).

Please download the Supplier’s Manual for registration procedures by clicking “Support” in eTENDER website.

If you have any queries or encounter any problems, please use the Support under the Login Menu or send us an email at hkstp@e-tendering.com.

***Download Tender document***

Login HKSTP Tender System > Search under “RFP/Tender Exercise” > Input the Ref. no. RFP/2023/CEOD/282 to search and download the document.